

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









APTD3216P3C-P22

3.2 x 1.6 mm Phototransistor



DESCRIPTION

· Made with NPN silicon phototransistor chips

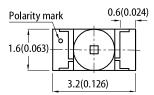
FEATURES

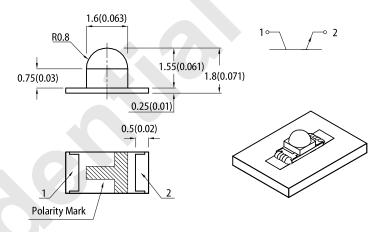
- 3.2 mm X 1.6mm SMD LED, 1.8 mm thickness
- · Mechanically and spectrally matched to infrared emitting LED lamp
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- RoHS compliant

APPLICATIONS

- · Infrared applied systems
- Optoelectronic switches
- Photodetector control circuits
- · Sensor technology

PACKAGE DIMENSIONS





RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: \pm 0.1)



- 1. All dimensions are in millimeters (inches).
- Tolerance is ±0.2(0.008") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to
- change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Max.Ratings	Units	
Collector-to-Emitter Voltage	30	V	
Emitter-to-Collector Voltage	5	V	
Power Dissipation at(or below) 25°C Free Air Temperature	100	mW	
Operating Temperature	-40 to +85	°C	
Storage Temperature	-40 to +85	°C	

Note:
1. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



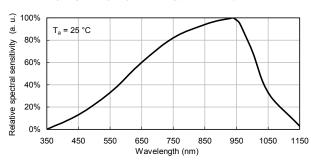


ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

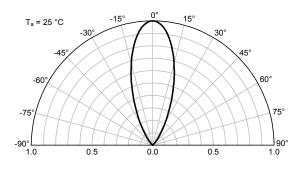
Parameter	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Collector-to-Emitter Breakdown Voltage	V BR CEO	30	-	-	V	I _C = 100uA Ee = 0mW/cm ²
Emitter-to-Collector Breakdown Voltage	V _{BR ECO}	5	-	-	V	I _E = 100uA Ee = 0mW/cm ²
Collector-to-Emitter Saturation Voltage	V _{CE (SAT)}	-	-	0.8	V	$I_C = 2mA$ Ee = $20mW/cm^2$
Collector Dark Current	I _{CEO}	-	-	100	nA	V _{CE} = 10V Ee = 0mW/cm ²
Rise Time(10% to 90%)	T _R	-	15		μS	V _{CE} = 5V IC = 1mA RL = 1000Ω
Fall Time(90% to 10%)	T _F	-	15		μS	
On State Collector Current	I _(ON)	0.4	1	-	mA	$V_{CE} = 5V$ $Ee = 1mW/cm^2$ $\lambda = 940nm$
Range of spectral bandwidth	λ _{0.1}	420		1120	nm	-
Wavelength of peak Sensitivity	λ_{p}		940	-	nm	-
Angle of half sensitivity	201/2	-	40	-	deg	-

TECHNICAL DATA

RELATIVE SPECTRAL SENSITIVITY vs. WAVELENGTH



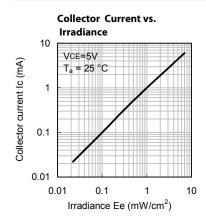
RELATIVE RADIANT SENSITIVITY vs. ANGULAR DISPLACEMENT

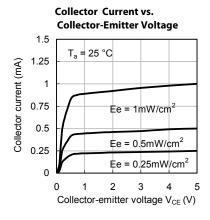


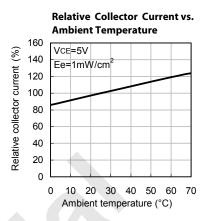


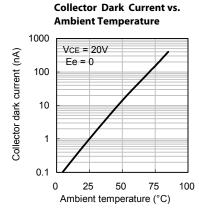
TECHNICAL DATA

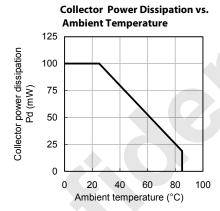
PHOTOTRANSISTOR

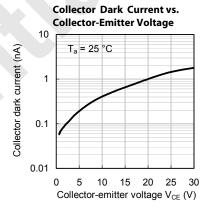




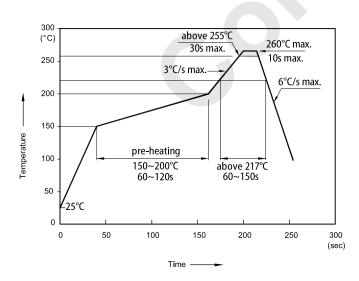




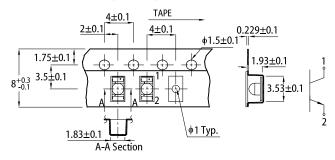




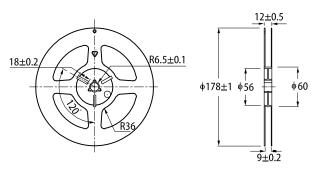
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



TAPE SPECIFICATIONS (units: mm)



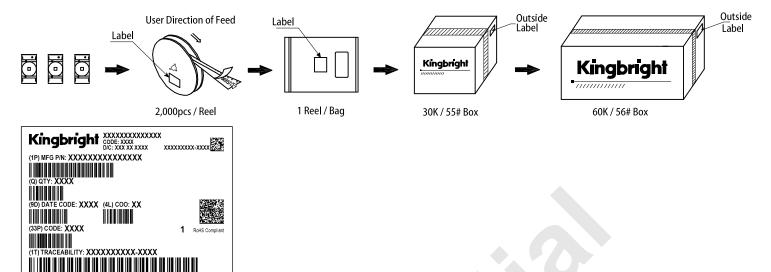
REEL DIMENSION (units: mm)



- 1. Don't cause stress to the LEDs while it is exposed to high temperature.
- The maximum number of reflow soldering passes is 2 times.
 Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.



PACKING & LABEL SPECIFICATIONS



- The information included in this document reflects representative usage scenarios and is intended for technical reference only.

 The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

 The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening
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